



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE  
Group Art Unit 1742

2004 AF\$

Patent Application of

Toshihide Ito

Application No. 09/671,084

Confirmation No.: 6569

Filed: September 27, 2000

Examiner: Sikyin Ip

“SN-AG-CU SOLDER AND SURFACE  
TREATMENT AND PARTS MOUNTING  
METHODS USING THE SAME”

I, Elizabeth M. Campbell Tressler, hereby certify that this correspondence is being deposited with the US Postal Service as first class mail in an envelope addressed to Commissioner for Patents, P.O. Box 1450, Alexandria VA 22313-1450, on the date of my signature.

Elizabeth M. Campbell Tressler  
Signature

5/2/2005  
Date of Signature

**TRANSMITTAL LETTER**

Mail Stop Appeal Brief - Patents  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

Enclosed for filing are the following documents:

Appeal Brief – 19 pages (in triplicate);

Exhibit A – 25 pages (in triplicate); and

Request for Extension of Time – 1 page (in duplicate).

Charge or credit Deposit Account 50-1965 with any shortage or overpayment of fees associated with this filing.

Respectfully submitted,

Date: May 2, 2005

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